## RECORDATION CO



LICATION

103060485

NAME OF CONVEYING PARTY

Chih-Hsien WEI and

Ming-Sheng YANG

NAME OF RECEIVING PARTY

**LITE-ON TECHNOLOGY** 

CORPORATION

ADDRESS OF RECEIVING PARTY

22Fl., No. 392, Ruey Kuang Road,

Nei-Hu Dist., Taipei, Taiwan, R.O.C.

NATURE OF CONVEYANCE

Assignment of U.S. Patent Application

CONVEYANCE EXECUTION DATE(s)

March 4, 2005

PATENT APPLICATION NO.

To be assigned

PATENT APPLICATION FILING DATE

August 5, 2005

APPLICATION FILED TOGETHER

WITH THIS DOCUMENT

YES

APPLICATION EXECUTION DATE(s)

March 4, 2005

CORRESPONDENCE

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ATTORNEY REFERENCE

**TAIW 391** 

TOTAL NUMBER OF PATENTS

AND APPLICATIONS INVOLVED

40.00 GP

One

TOTAL FEE PAID

\$40.00

**METHOD OF PAYMENT** 

**Enclosed** [X]

Authorized to be charged to

deposit account

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Total number of pages including cover sheet, attachments and document: 2.

Steven M. Rabin (Reg. No. 29,102)

August 5, 2005

Date

**PATENT** 

REEL: 016869 FRAME: 0854

Please charge any further fee to our Deposit Account **ENCLOSED:**\$

FC:8021

**RECORDED: 08/05/2005** 

| Attorney | Reference |  |
|----------|-----------|--|
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## ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT

| WHEREAS (1) Chih-Hsien W  | /EI (2) Ming-Sheng YANG   |   |
|---|---|---|
| hereinafter referred to collectively as   | the assignor, has invented a certa  | ain improvement relating to   |
| <ul><li>[x] the inventor(s) declaration for satisfactors</li><li>instrument; said application to be filed</li><li>[] said application having been filed</li></ul> | ed in the United States Patent and<br>I in the United States Patent and T | rademark Office on,   |
| Avruch and Allen Wood of RABIN  | & BERDO, P.C., 1101 14 <sup>th</sup> Street,                              | n, Robert H. Berdo, Jr., Phillip G. N.W., Suite 500, Washington, D.C. |
| said application when known;  |   | ) the application serial number of                                    |
| [ ] said application having been filed, (Serial No  | under the Patent Cooperation Tre)the United States of America             | eaty on<br>being designated.  |
| AND WHEDEAS LITE ON TE  |   |   |
| AND WHEREAS LITE-ON TE  |   | Faire I Takwan B O C  |
| who's address is 22Fl., No. 392, F  | tuey Kuang Road, Nel-Hu Dist.,  | raipei, raiwan, R.O.C.  |
|   |   | Aine similar did no allina and in                                     |
| hereinafter referred to as the assign<br>said application, including any and a<br>any and all patents which may b<br>prolongations thereof;                       | Il divisions and continuations there                                      | of, and in and to said invention and                                  |
| NOW THIS WITNESSETH, that   |   | Dollar (\$1.00), and other good and                                   |
| valuable consideration paid by s  |   |   |
| acknowledged, said assignor hereb   |   |   |
| successors and assigns, the full and  |   |   |
| any and all divisions and continuatio<br>may be granted therefore, includir   |   |   |
| assignee, and said assignee's suc   |   |   |
| application, including any and all div  |   |   |
| all patents which may be granted t  |   |   |
| thereof, with all the rights, powers,   |   |   |
| thereto, for and during the term or to  |   |   |
| renewals, reissues and prolongation   |   |   |
| assignee's successors and assigns,  |   |   |
| could have held and enjoyed the sar   |   |   |
|   |   | f said assignee, or said assignee's                                   |
| successors or assigns, any and al   |   | r to the asserting of said patents,                                   |
| including any and all renewals, reiss   |   | f Patents and Trademarks to issue                                     |
| Letters Patent on said application, at  |   |   |
| to said assignee, and said assignee'  |   |   |
| Chih-Hsien WEI  | Chih-hsien Wi   | 2005,0304   |
| Name of sole or first inventor  | Signature   | Date  |
| Ming-Sheng YANG   | Ming - Shang J  | ang 2005-Max-4th  |
| Name of second inventor, if any   | Signature   | Date  |
|   |   |   |
|   |   |   |
| Name of third inventor, if any  | Signature   | Date  |

PATENT REEL: 016869 FRAME: 0855